

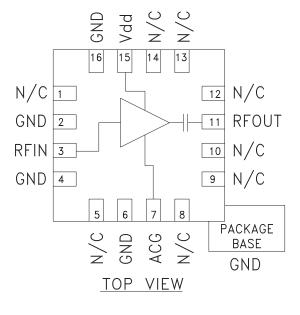


Typical Applications

The HMC356LP3 / HMC356LP3E is ideal for basestation receivers:

- GSM 450 & GSM 480
- CDMA 450
- Private Land Mobile Radio

Functional Diagram



HMC356LP3 / 356LP3E

GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 350 - 550 MHz

Features

Noise Figure: ≤1.0 dB +38 dBm Output IP3 Gain: 17 dB Very Stable Gain vs. Supply & Temperature Single Supply: +5V @ 104 mA 50 Ohm Matched Output

General Description

The HMC356LP3 & HMC356LP3E are high dynamic range GaAs PHEMT MMIC Low Noise Amplifiers is ideal for GSM & CDMA cellular basestation and Mobile Radio front-end receivers operating between 350 and 550 MHz. This LNA has been optimized to provide 1.0 dB noise figure, 17 dB gain and +38 dBm output IP3 from a single supply of +5V @ 104 mA. Input and output return losses are 15 dB typical, with the LNA requiring only four external components to optimize the RF input match, RF ground and DC bias. For applications which require improved noise figure, please see the HMC616LP3(E).

Electrical Specifications, $T_{A} = +25^{\circ} C$, Vs = +5V

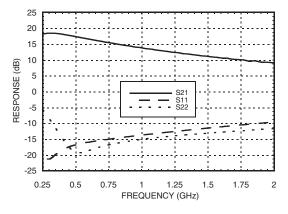
| Parameter | Min. | Тур. | Max. | Units |
|--|------|--------------|-------|---------|
| Frequency Range | | 350 - 550 MH | | MHz |
| Gain | 15 | 17 | | dB |
| Gain Variation Over Temperature | | 0.0032 | 0.010 | dB / °C |
| Noise Figure | | 1.0 | 1.4 | dB |
| Input Return Loss | | 17 | | dB |
| Output Return Loss | | 12 | | dB |
| Reverse Isolation | | 24 | | dB |
| Output Power for 1dB Compression (P1dB) | 17 | 21 | | dBm |
| Saturated Output Power (Psat) | | 22.5 | | dBm |
| Output Third Order Intercept (IP3) (-20 dBm Input Power per tone, 1 MHz tone spacing) | 34 | 38 | | dBm |
| Supply Current (Idd) | | 104 | | mA |

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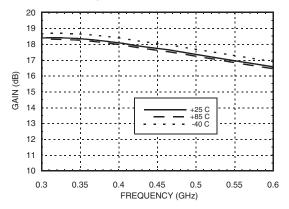




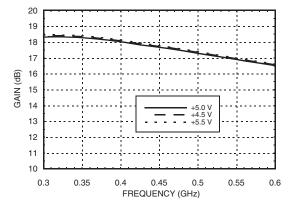
Broadband Gain & Return Loss



Gain vs. Temperature

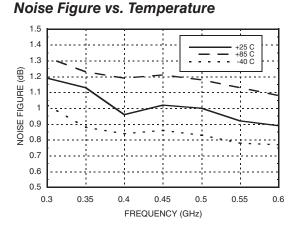


Gain vs. Vdd

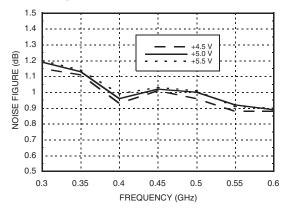


HMC356LP3 / 356LP3E

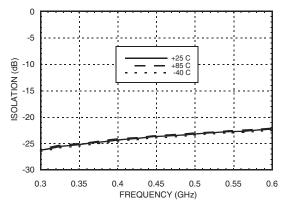
GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 350 - 550 MHz



Noise Figure vs. Vdd



Reverse Isolation



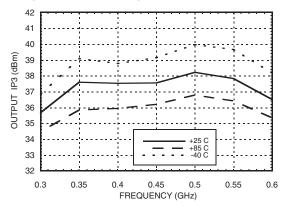
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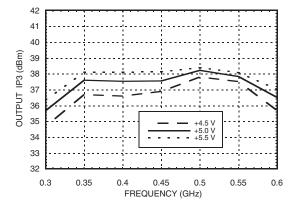


Input Return Loss vs. Temperature -5 RETURN LOSS (dB) +25 C +85 C -40 C -10 -15 -20 -25 0.3 0.35 0.4 0.45 0.5 0.55 0.6 FREQUENCY (GHz)

Output IP3 vs. Temperature

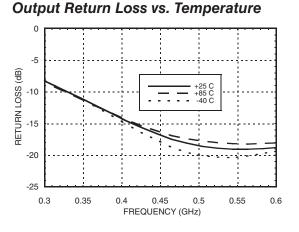


Output IP3 vs. Vdd

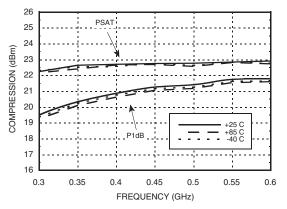


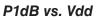
HMC356LP3 / 356LP3E

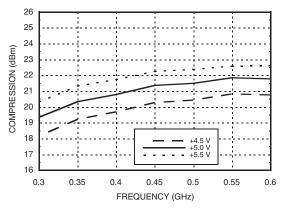
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P1dB & Psat vs. Temperature







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Absolute Maximum Ratings

| | - |
|---|----------------|
| Drain Bias Voltage (Vdd) | +8.0 Vdc |
| RF Input Power (RFIN)(Vdd = +5.0 Vdc) | +15 dBm |
| Channel Temperature | 150 °C |
| Continuous Pdiss (T = 85 °C) (derate 14 mW/°C above 85 °C) | 0.910 W |
| Thermal Resistance (channel to ground paddle) | 71.4 °C/W |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |

HMC356LP3 / 356LP3E

GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 350 - 550 MHz

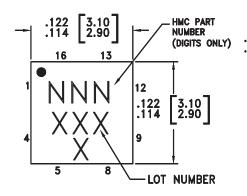
Typical Supply Current vs. Vdd

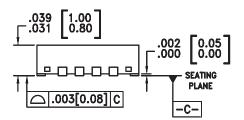
| Vdd (Vdc) | ldd (mA) |
|-----------|----------|
| +4.5 | 103 |
| +5.0 | 104 |
| +5.5 | 105 |



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing





BOTTOM VIEW .016 [0.40] REF PIN 16 .012 0.30 .007 0.18 .008 [0.20] MIN ЧΠ Ц PIN 1 0.56 1.56 1.44 .061 hпп EXPOSED GROUND PADDLE 1.95 1.50 .077 .059 MUST BE CONNECTED TO **RF/DC GROUND** SOUARE

NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
- PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE
- SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ^[3] |
|-------------|--|---------------|---------------------|--------------------------------|
| HMC356LP3 | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL1 [1] | 356 XXXX |
| HMC356LP3E | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 ^[2] | <u>356</u> XXXX |

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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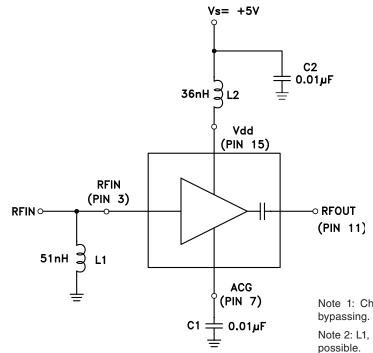
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Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|-------------------------------|----------|---|---------------------|
| 1, 5, 8, 9, 10, 12, 13, 14 | N/C | No connection necessary. These pins may be connected to RF/DC ground. | |
| 2, 4, 6,16 | GND | These pins and package ground paddle must be connected to RF/DC ground. | |
| 3 | RFIN | This pin is matched to 50 Ohms with a 51 nH inductor to ground. See Application Circuit. | RFIN O |
| 7 | ACG | AC Ground - An external capacitor of 0.01µF to ground is required for low frequency bypassing. See Application Circuit for further details. | ACG O |
| 11 | RFOUT | This pin is AC coupled and matched to 50 Ohms. | |
| 15 | Vdd | Power supply voltage. Choke inductor and bypass capacitor are required. See application circuit. | ACG O |

Application & Evaluation PCB Circuit



Note 1: Choose value of capacitor C1 for low frequency bypassing. A 0.01 μF ±10% capacitor is recommended.

Note 2: L1, L2 and C1 should be located as close to pins as possible.

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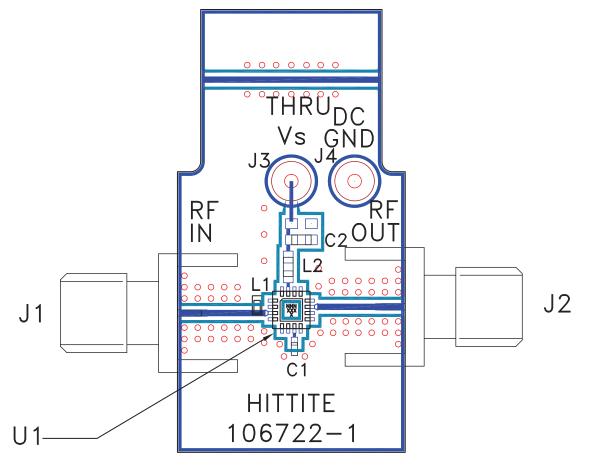


HMC356LP3 / 356LP3E

GaAs PHEMT MMIC LOW NOISE AMPLIFIER, 350 - 550 MHz



Evaluation PCB



List of Materials for Evaluation PCB 107795 [1]

| Item | Description | |
|---------|----------------------------------|--|
| J1 - J2 | PCB Mount SMA RF Connector | |
| J3 - J4 | DC Pin | |
| C1 | 10,000 pF Capacitor, 0402 Pkg. | |
| C2 | 10,000 pF Capacitor, 0603 Pkg. | |
| L1 | 51 nH Inductor, 0402 Pkg. | |
| L2 | 36 nH Inductor, 0603 Pkg. | |
| U1 | HMC356LP3 / HMC356LP3E Amplifier | |
| PCB [2] | 106722 Evaluation PCB | |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

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